506955738 11/02/2021 PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:		NEW ASSIGNMENT		
NATURE OF CONVEY	NCE: ASSIGNMENT			
CONVEYING PARTY	ΔΑΤΑ			
		Name	Execution Date	
HSIU-YU CHANG			09/02/2021	
CHAO-TING LIN			09/02/2021	
RECEIVING PARTY D				
Name:	UCINIEC	CO., LTD.		
Name: Street Address:		&D 2ND RD., SCIENCE-BASED	INDUSTRIAL PARK	
		&D 2ND RD., SCIENCE-BASED	INDUSTRIAL PARK	

PROPERTY NUMBERS Total: 1

Postal Code:

Property Type	Number	
Application Number:	17517144	

33076

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:		22939.22	
NAME OF SUBMITTER:		EVAN R. WITT	
SIGNATURE:		/Evan R. Witt/	
DATE SIGNED:		11/02/2021	
Total Attachments: 1 source=22939-22_ASSIGN#page	1.tif		

ASSIGNMENT OF APPLICATION FOR UNITED STATES LETTERS PATENT

WHEREAS HSIU-YU CHANG, CHAO-TING LIN

hereinafter referred to collectively as the assignor, has invented a certain improvement relating to

CHIP RESISTOR STRUCTURE

[x] the inventor(s) declaration for said application being executed concurrently with the execution of this instrument: said application to be filed in the United States Patent and Trademark Office; [] said application having been filed in the United States Patent and Trademark Office on ____

(Application Serial No. _____) the application serial number of said application when known; [] said application having been filed under the Patent Cooperation Treaty on ______

CYNTEC CO., LTD. AND WHEREAS

who's address is No. 2, R&D 2nd RD., Science-Based Industrial Park, Hsinchu 30076, Taiwan, R.O.C.

hereinafter referred to as the assignee, is desircus of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof;

NOW THIS WITNESSETH, for good and valuable consideration, the receipt of which is hereby acknowledged, said assignor hereby assigns, transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefore, including any and all renewals, reissues and prolongations thereof, said assignes, and said assignce's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as the said assignor might or could have held and enjoyed the same, if this assignment had not been made.

AND said assignor hereby agrees to perform, upon the request of said assignee, or said assignee's successors or assigns, any and all acts relating to the obtaining or to the asserting of said patents, including any and all renewals, reissues and prolongations thereof.

AND said assignor authorizes and requests the Commissioner of Patents and Trademarks to issue Letters Patent on said application, and on any and all divisions and continuations thereof,

to said assignee, and said assignee's successors and assigns, in accordance herewith.

HSIU-YU CHANG	HSIU-TU CHANG	2021.9.2
Name	Signature	Date
CHAO-TING LIN	CHAD-TING LIN	20=1.9.2
Name	Signature	Date